

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
INTERNATIONAL MEDICAL INDUSTRIES INC.	07/22/2021
RECEIVING PARTY DATA	
Name:	MEDICAL DEVICE ENGINEERING, LLC,
Street Address:	2981 GATEWAY DRIVE
City:	POMPANO BEACH
State/Country:	FLORIDA
Postal Code:	33069
PROPERTY NUMBERS Total: 1	
Property Type	Number
Patent Number:	11040149
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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ATTORNEY DOCKET NUMBER:	1354.1.739.17
NAME OF SUBMITTER:	JENNIE S. MALLOY
SIGNATURE:	/Jennie S. Malloy/
DATE SIGNED:	11/16/2021
Total Attachments: 2	
source=2021-07-23 Assignment to MDE re Patent Application for 11040149 MM Ref 1739-17#page1.tif	
source=2021-07-23 Assignment to MDE re Patent Application for 11040149 MM Ref 1739-17#page2.tif	

ASSIGNMENT OF RIGHTS TO PATENT APPLICATION(S) & INVENTION(S)

WHEREAS, International Medical Industries Inc. is a corporation organized and existing under laws of the State of Florida (hereinafter the "**ASSIGNOR**"), with a current address of 2981 Gateway Drive, Pompano Beach, Florida 33069.

WHEREAS, ASSIGNOR is the owner of all rights, title, and interest in the inventions of its employees, by way of separate assignments as well as separate employment agreements, and specifically, is the current owner of all rights, title and interest in and to the following inventions and U.S. patents that have issued for the same, as shown by the records of the U.S. Patent & Trademark Office:

- (1) U.S. Patent Application No. 15/941,295 for --
Title of Invention: TAMPER EVIDENT CLOSURE ASSEMBLY FOR A
MEDICAL DEVICE
(Attorney File/Docket No. 1354.1.739.17)

WHEREAS, Medical Device Engineering, LLC, is a limited liability company organized and existing under the laws of the State of Florida (hereinafter the "**ASSIGNEE**"), with a current address of 2981 Gateway Drive, Pompano Beach, Florida 33069, and is desirous of acquiring the entire right, title, and interest in and to the aforesaid invention(s), and the aforesaid U.S. Letters Patent, to be reflected in the name of **ASSIGNEE**, and therefore wishes to document and record this transfer of rights by **ASSIGNOR** in the same.

NOW, THEREFORE, in exchange for Twenty U.S. Dollars (US\$20.00) and other good and valuable consideration, the receipt and sufficiency of which is acknowledged, **ASSIGNOR** agrees to assign and transfer and does hereby assign and transfer unto **ASSIGNEE**, its successors and assigns, for the territory of the United States of America, and to the extent applicable also in all foreign countries, the entire right, title, and interest in and to the aforesaid invention(s), aforesaid U.S. Letters Patent, and to any further Letters Patent that may issue thereon, and to any related U.S. patent applications filed with a claim of priority to the same, whether a continuation, continuation-in-part, divisional, reissues, reexaminations, and extensions thereof, to be held and enjoyed as fully and exclusively as they would have been by **ASSIGNOR**, had this Assignment and transfer not been made, including the right to sue for all past and future damages related thereto.

AND FURTHER, the undersigned does hereby also agree on behalf of **ASSIGNOR**, its successors and assigns, to execute, have executed and deliver without further consideration any further assignments and/or other documents, and to perform such other acts as **ASSIGNEE**, its successors, assigns, or nominees, may lawfully deem necessary or expedient to fully secure its interest as aforesaid and to obtain and/or maintain the above noted Letters Patent in the United States, including any related U.S. patent applications as noted herein;

